HALOGEN

FREE



Vishay Siliconix

N-Channel 8 V (D-S) MOSFET

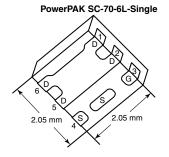
PRODUCT SUMMARY									
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ Max.	I _D (A) ^a	Q _g (Typ.)						
	0.0094 at V _{GS} = 4.5 V	12							
	0.0105 at V _{GS} = 2.5 V	12							
8	0.0125 at V _{GS} = 1.8 V	12	15 nC						
	0.0180 at V _{GS} = 1.5 V	12							
	0.0360 at V _{GS} = 1.2 V	12							

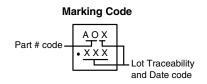
FEATURES

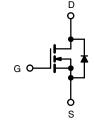
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
- 100 % R_q Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch for Portable Applications such as Smart Phones, Tablet PCs and Mobile Computing
 - Low Voltage Gate Drive
 - Low Voltage Drop
 - Power Switch for ICs







Ordering Information: SiA436DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)									
Parameter		Symbol	Limit	Unit					
Drain-Source Voltage		V_{DS}	8	V					
Gate-Source Voltage		V_{GS}	± 5	v					
	T _C = 25 °C		12 ^a						
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	12 ^a						
Continuous Brain Current (1) = 100 °C)	T _A = 25 °C		12 ^{a, b, c}						
	T _A = 70 °C		12 ^{a, b, c}	A					
Pulsed Drain Current (t = 300 μs)		I _{DM}	50						
Continuous Source-Drain Diode Current			12 ^a						
Continuous Source-Drain Diode Guirent	T _A = 25 °C	I _S	2.9 ^{b, c}						
	T _C = 25 °C		19						
Maximum Power Dissipation	$T_C = 70 ^{\circ}C$	P _D	12	w					
Waximum rower bissipation	T _A = 25 °C	. п	3.5 ^{b, c}	**					
	T _A = 70 °C		2.2 ^{b, c}						
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C						
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260						

THERMAL RESISTANCE RATINGS										
Parameter		Symbol	Typical	Maximum	Unit					
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W					
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	5.3	6.5	0///					

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/ppq273257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
 e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 80 °C/W.

Document Number: 63535 S11-2242-Rev. A, 14-Nov-11

SiA436DJ

Vishay Siliconix



SPECIFICATIONS ($T_J = 25 ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	Symbol	rest conditions	IVIIII.	тур.	IVIAX.	Onic
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	8			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	VGS = 0 V, 1D = 200 μ V		11		, v
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 2.5		mV/°C
Gate-Source Threshold Voltage		$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.35	- 2.5	0.8	V
Gate-Source Leakage	V _{GS(th)}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$	0.55		± 100	-
Gale-Source Leakage	I _{GSS}	$V_{DS} = 8 \text{ V}, V_{GS} = 2 \text{ V}$ $V_{DS} = 8 \text{ V}, V_{GS} = 0 \text{ V}$				nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 8 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			1	μΑ
					10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α
		V _{GS} = 4.5 V, I _D = 15.7 A		0.0078	0.0094	
	_	V _{GS} = 2.5 V, I _D = 14.9 A		0.0087	0.0105	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 1.8 V, I _D = 13.6 A		0.0104	0.0125	Ω
		$V_{GS} = 1.5 \text{ V}, I_D = 2.5 \text{ A}$		0.0120	0.0180	
		$V_{GS} = 1.2 \text{ V}, I_D = 1.5 \text{ A}$		0.0180	0.0360	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 4 \text{ V}, I_{D} = 15.7 \text{ A}$		70		S
Dynamic ^b						
Input Capacitance	C _{iss}			1508		
Output Capacitance	C _{oss}	$V_{DS} = 4 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		535		pF
Reverse Transfer Capacitance	C _{rss}			321		
Tatal Cata Chausa	Q _g	$V_{DS} = 4 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 15.7 \text{ A}$		16.8	25.2	nC
Total Gate Charge				15	23	
Gate-Source Charge		$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 15.7 \text{ A}$		1.7		
Gate-Drain Charge	Q _{gd}			0.9		
Gate Resistance	R_{g}	f = 1 MHz	0.5	2.5	5	Ω
Turn-on Delay Time	t _{d(on)}			11	20	
Rise Time	t _r	1 , , , , , , , , , , , , , , , , , , ,		10	20	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 4 \text{ V}, R_L = 0.4 \Omega$ $I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$		30	45	1
Fall Time	t _f	$I_D = 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, N_g = 1.52$		8	16	
Turn-on Delay Time	t _{d(on)}			10	20	ns
Rise Time	t _r	1 <u>-</u>		10	20	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 4 \text{ V}, R_L = 0.4 \Omega$		30	45	
Fall Time	t _f	$I_D \cong 10 \text{ A}, V_{GEN} = 5 \text{ V}, R_g = 1 \Omega$		8	16	
Drain-Source Body Diode Characteristic						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			12	
Pulse Diode Forward Current	I _{SM}	-			50	- A
Body Diode Voltage	V _{SD}	I _S = 10 A, V _{GS} = 0 V		0.73	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			10	20	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1		1	4	nC
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		4		
Reverse Recovery Rise Time	t _b	1		6		ns

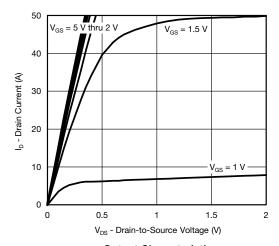
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

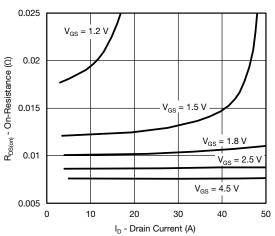


Vishay Siliconix

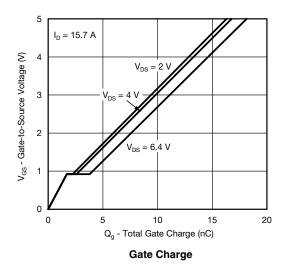
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

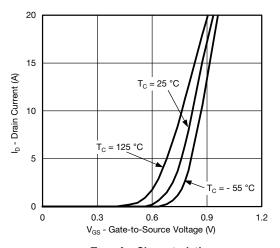


Output Characteristics

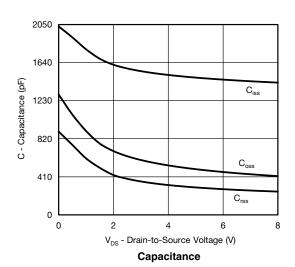


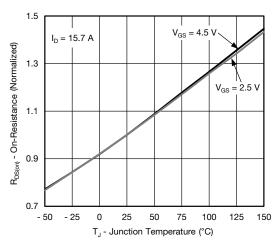
On-Resistance vs. Drain Current and Gate Voltage





Transfer Characteristics



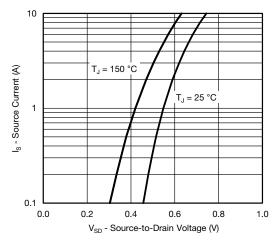


On-Resistance vs. Junction Temperature

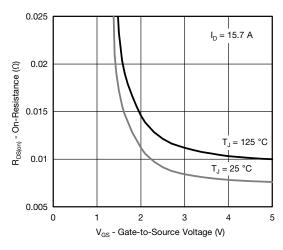
SiA436DJ

Vishay Siliconix

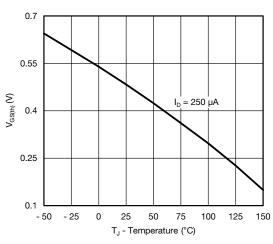
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



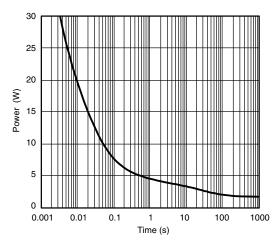
Source-Drain Diode Forward Voltage



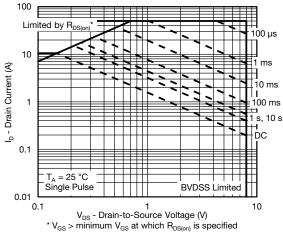
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power (Junction-to-Ambient)

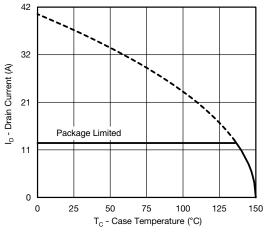


Safe Operating Area, Junction-to-Ambient

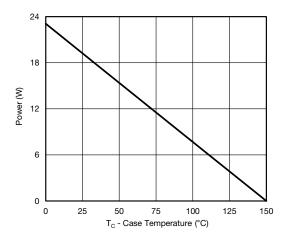


Vishay Siliconix

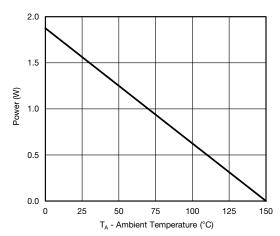
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*



Power Derating, Junction-to-Case



Power Derating, Junction-to-Ambient

Document Number: 63535 S11-2242-Rev. A, 14-Nov-11

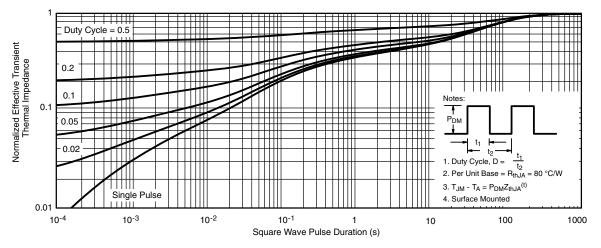
 $^{^*}$ The power dissipation P_D is based on $T_{J(max.)}$ = 150 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiA436DJ

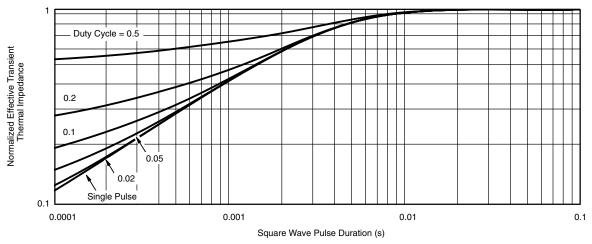
Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

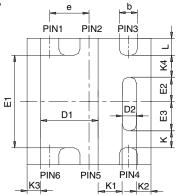
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63535





Vishay Siliconix

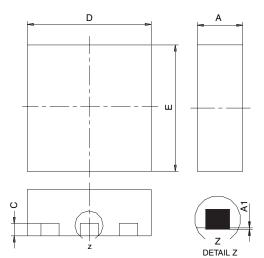
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

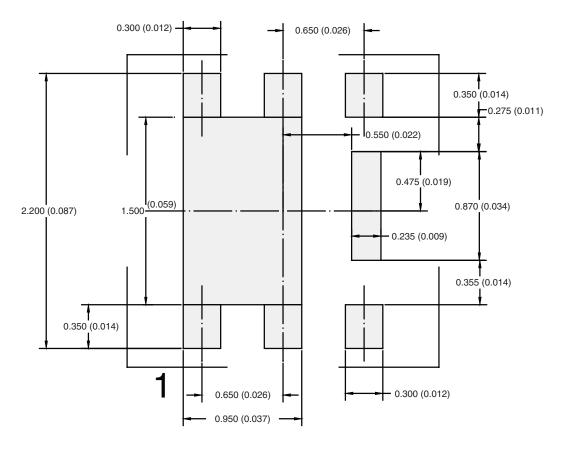
	SINGLE PAD						DUAL PAD						
DIM	M	ILLIMETER	RS	INCHES			MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC			
K		0.275 TYP	١		0.011 TYP		0.275 TYP			0.011 TYP			
K1		0.400 TYP	١		0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP	١		0.009 TYP			0.252 TYP			0.010 TYP		
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP	1		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
FCN: C-07431 - Bey C 06-Aug-07													

DWG: 5934

Document Number: 73001 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

Return to Index

ATTLICATION NOT



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

SIA436DJ-T1-GE3